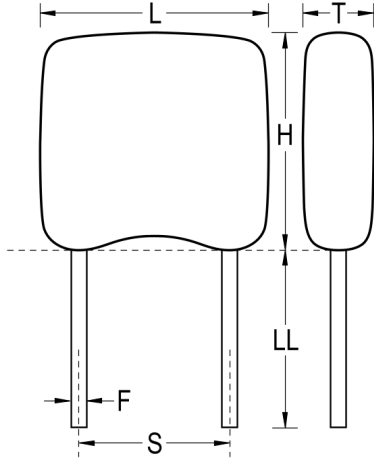


HP08CN104KN

Aliases (HP08CN104K)

HP LDD Indust COG HT200C, Ceramic, 0.1 uF, 10%, 100 VDC, COG, High Temperature, Lead Spacing = 10.16mm



Click [here](#) for the 3D model.

Dimensions	
L	12.7mm MAX
H	12.7mm MAX
T	6.35mm MAX
S	10.16mm +/-0.762mm
LL	3.175mm MIN
F	0.635mm +0.102/-0.051mm

Packaging Specifications	
Packaging	Waffle, Tray
Packaging Quantity	28

General Information	
Series	HP LDD Indust COG HT200C
Style	Radial
Description	High Temperature
Features	LDD High Temperature 200C
RoHS	No
Prop 65	⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov .
SCIP Number	bf6a1307-d7a0-4f9d-aab0-ab892fbcccd4
Termination	Nickel
Failure Rate	N/A
AEC-Q200	No

Specifications	
Capacitance	0.1 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	100 VDC
Dielectric Withstanding Voltage	250 VDC
Temperature Range	-55/+200°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	±30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.15% 1 kHz 1.0Vrms
Insulation Resistance	10 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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[>>KEMET\(基美\)](#)